

RJK0304DPB

Silicon N Channel Power MOS FET Power Switching

REJ03G1352-0600 Rev.6.00 Apr 19, 2006

Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance $R_{DS(on)} = 4.0 \ m\Omega \ typ. \ (at \ V_{GS} = 10 \ V)$

Outline

RENESAS Package code: PTZZ0005DA-A (Package name: LFPAK)

5
D
1, 2, 3 Source
4 Gate
5 Drain

Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

			(1a 25 C)	
Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DSS}	30	V	
Gate to source voltage	V _{GSS}	+16/-12	V	
Drain current	I _D	35	A	
Drain peak current	I _{D(pulse)} Note1	140	A	
Body-drain diode reverse drain current	I _{DR}	35	A	
Avalanche current	I _{AP} Note 2	14	А	
Avalanche energy	E _{AR} Note 2	19	mJ	
Channel dissipation	Pch Note3	50	W	
Channel to Case Thermal Resistance	θch-C	2.5	°C/W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

- 2. Value at Tch = 25°C, Rg \geq 50 Ω
- 3. $Tc = 25^{\circ}C$

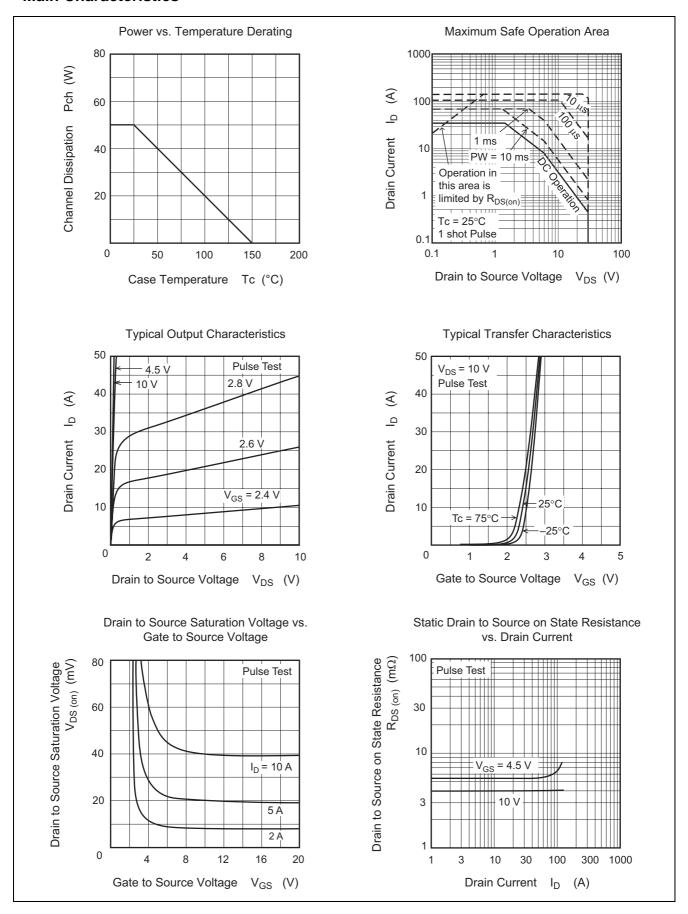
Electrical Characteristics

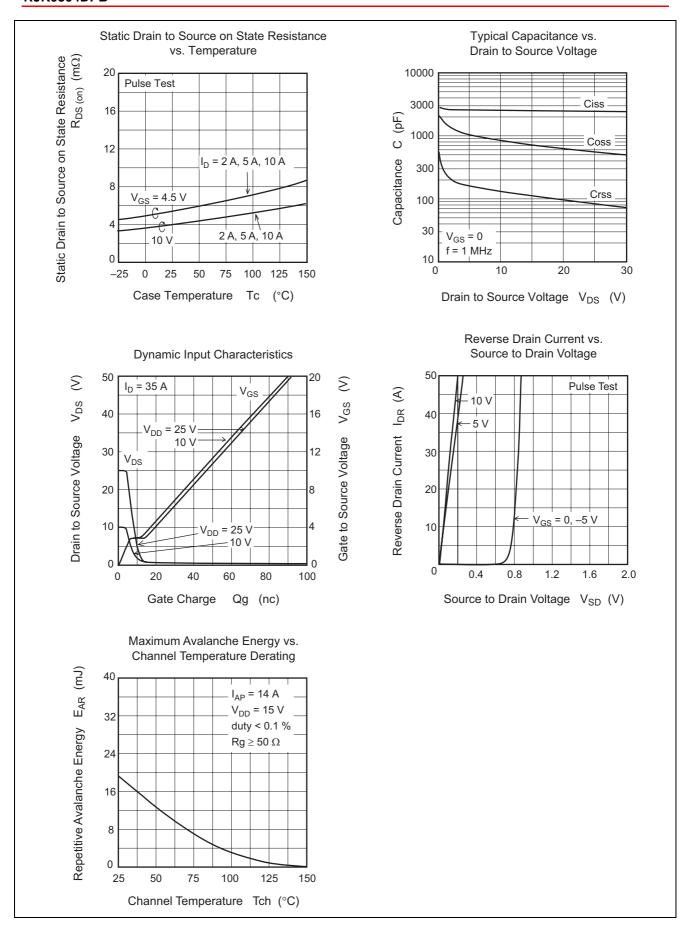
 $(Ta = 25^{\circ}C)$

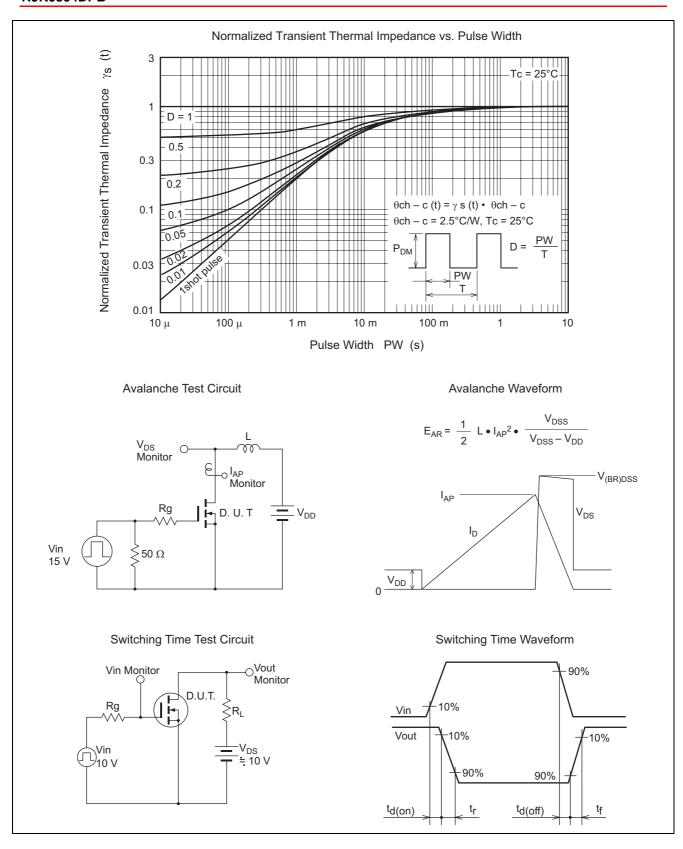
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	_	± 0.1	μΑ	$V_{GS} = +16/-12 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.2	_	2.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	_	4.0	4.8	mΩ	$I_D = 17.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R _{DS(on)}	_	5.5	7.2	mΩ	$I_D = 17.5 \text{ A}, V_{GS} = 4.5 \text{ V}$ Note4
Forward transfer admittance	y _{fs}	_	60	_	S	$I_D = 17.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	2500	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	850	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	130	_	pF	
Gate Resistance	Rg	_	0.5	_	Ω	
Total gate charge	Qg	_	17	_	nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$
Gate to source charge	Qgs	_	6.7		nC	$I_D = 35 \text{ A}$
Gate to drain charge	Qgd	_	3.7	_	nC	
Turn-on delay time	t _{d(on)}	_	8.5	_	ns	$V_{GS} = 10 \text{ V}, I_D = 17.5 \text{ A},$
Rise time	t _r	_	3.2	_	ns	$V_{DD} \cong 10 \text{ V,R}_L = 0.57 \Omega,$
Turn-off delay time	$t_{d(off)}$	_	41	_	ns	$Rg = 4.7 \Omega$
Fall time	t _f	_	4.0	_	ns	
Body-drain diode forward voltage	V_{DF}		0.84	1.10	V	IF = 35 A, V _{GS} = 0 Note4
Body-drain diode reverse recovery time	t _{rr}	_	35	_	ns	$IF = 35 \text{ A}, V_{GS} = 0$ $di_{F}/dt = 100 \text{ A}/\mu \text{s}$

Notes: 4. Pulse test

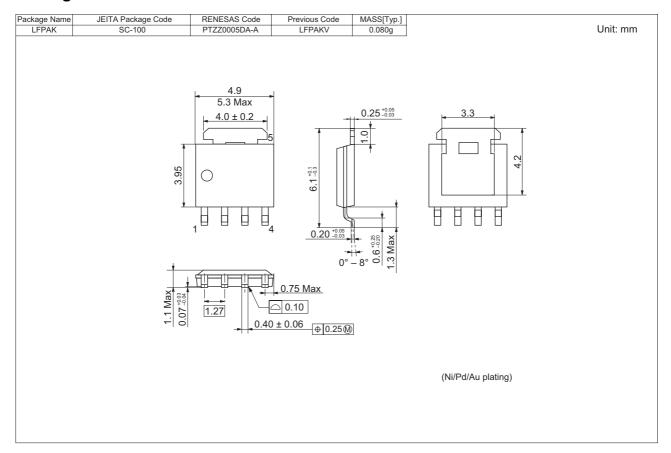
Main Characteristics







Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
RJK0304DPB-00-J0	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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